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DISCLOSEABLE TRANSACTION SUPPLEMENTAL DEED TO THE LOAN AGREEMENT

On 17 January 2018, the Lender entered into the Supplemental Deed with the Borrower A to extend the Repayment Date to the New Repayment Date and revise down the principal of the Loan Facility A to HK\$125,000,000. As at the date of this announcement, HK\$25,000,000 of the principal amount of Loan Facility A has been repaid and outstanding balance is HK\$125,000,000. Accrued interest of the Loan Facility A has been paid. Subject only to the Extension and the revised loan principal, the Prior Loan Agreement shall remain in full force and effect.

As one or more of the applicable percentage ratios under Rule 14.07 of the Listing Rules with respect to the Supplemental Deed alone and, as well as when aggregated with the Loan Facility B, exceeds 5% but not more than 25%, the Supplemental Deed and the provision of Loan Facility B, on an aggregate basis, constitutes a discloseable transaction of the Company under Chapter 14 of the Listing Rules and is therefore subject to notification and announcement requirements under the Listing Rules.

Reference is made to the announcements of the Company dated 16 October 2017 and 23 November 2017 respectively, in relation to the provision of the Loan Facility A and Loan Facility B. Unless otherwise defined, capitalized terms used in this announcement shall have the same meaning given to them in the announcement of the Company dated 23 November 2017.

On 17 January 2018, the Lender entered into the Supplemental Deed with the Borrower A to extend the Repayment Date to the New Repayment Date and revise down the principal of the Loan Facility A to HK\$125,000,000. As at the date of this announcement, HK\$25,000,000 of the principal amount of Loan Facility A has been repaid and outstanding balance is HK\$125,000,000. Accrued interest of the Loan Facility A has been paid. Subject only to the Extension and the revised loan principal, the Prior Loan Agreement shall remain in full force and effect.

SUPPLEMENTAL DEED

Key terms of the Supplemental Deed are set out as below:

Date : 17 January 2018

Lender : Sun Power Finance Limited, a company incorporated in Hong

Kong with limited liability and an indirect wholly owned

subsidiary of the Company

Borrower : Company A, a company incorporated in Hong Kong with limited

liability, to the best of the Directors' knowledge, information and belief, having made all reasonable enquiry, is an Independent Third Party and not connected with the Group as at the date of

this announcement

Principal amount : HK\$125,000,000

Interest rate : 15% per annum

Repayment date : 17 April 2018, option to extend three (3) months

INFORMATION OF THE BORROWER A

The Borrower A is a company incorporated in Hong Kong with limited liability and is engaged in the business of money lending. To the best of the Directors' knowledge, information and belief having made all reasonable enquiries, Borrower A is an Independent Third Party and not connected with the Group.

REASONS FOR AND BENEFITS OF THE SUPPLEMENTAL DEED

The principal business activities of the Group are (i) exploration, development and mining of copper and other mineral resources materials, (ii) investment in financial instruments, (iii) property investment, (iv) money lending and (v) e-logistics platform. The Lender is a licensed money lender holding a valid money lender licence under the Money Lenders Ordinance (Chapter 163 of the Laws of Hong Kong) and is principally engaged in the business of money lending.

The provision of the Loan Facility A under the Prior Loan Agreement and the Supplemental Deed is in ordinary and usual course of business of the Group which provides interest income to the Group, the partial repayment and accrued interest of the Loan Facility A has been paid as at the date of this announcement. Having considered the financial background of the Borrower A and the interest income to be received by the Group, the Directors consider that the terms of the Supplemental Deed are fair and reasonable and in the interests of the Company and Shareholders as a whole.

LISTING RULES IMPLICATIONS

As one or more of the applicable percentage ratios under Rule 14.07 of the Listing Rules with respect to the Supplemental Deed alone and, as well as when aggregated with the Loan Facility B, exceeds 5% but not more than 25%, the Supplemental Deed and the provision of Loan Facility B, on an aggregate basis, constitutes a discloseable transaction of the Company under Chapter 14 of the Listing Rules and is therefore subject to notification and announcement requirements under the Listing Rules.

DEFINITIONS

In this announcement, the following expressions have the meanings set out below unless the context otherwise requires:

"Extension" the extension of the Repayment Date to the New Repayment

Date

"New Repayment Date" 17 April 2018

"Repayment Date" 17 January 2018

"Supplemental Deed" A supplemental deed dated 17 January 2018 entered into

between the Lender and the Borrower A in relation to the extension of repayment date and revision of the loan principal

of the Loan Facility A

By Order of the Board
CST Group Limited
Chiu Tao

Executive Director and Chairman

Hong Kong, 17 January 2018

As at the date of this announcement, the board of the Company comprises (i) Mr. Chiu Tao (Chairman), Mr. Hui Richard Rui, Mr. Lee Ming Tung, Mr. Kwan Kam Hung, Jimmy, Mr. Yeung Kwok Yu, Mr. Tsui Ching Hung, Mr. Chen Weixing and Mr. Wah Wang Kei, Jackie as executive directors of the Company; and (ii) Mr. Yu Pan, Ms. Tong So Yuet, Ms. Ma Yin Fan and Mr. Leung Hoi Ying as independent non-executive directors of the Company.